506010613 04/13/2020

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6057324

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Geeng-Chuan Chern	03/25/2020

RECEIVING PARTY DATA

Name:	HeFeChip Corporation Limited	
Street Address:	Room 3A, 12th floor, Kaiser Centre, No.18 Centre Street	
City:	Sai Ying Pun	
State/Country:	HONG KONG	

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	16846424	

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	HFCP0027USA
NAME OF SUBMITTER:	KATE YEH
SIGNATURE:	/KATE YEH/
DATE SIGNED:	04/13/2020

Total Attachments: 2 source=3791912#page1.tif source=3791912#page2.tif

> **PATENT** REEL: 052374 FRAME: 0552 506010613

COMBINE DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT

Title of Invention:

MOS TRANSISTOR HAVNG LOWER GATE-TO-SORUCE/DRAIN BREAKDOWN VOLTAGE AND ONE-TIME PROGRAMMABLE MEMORY DEVICE USING THE SAME

As the below named inventor, I hereby declare that This declaration is directed to:	t:				
☑ The attached application, or					
☐ United States application number		_filed on, or			
□ PCT international application number		filed on			
The above-identified application was made or authorized to be made by me.					
I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.					
I hereby acknowledge that any willful false statement made in this declaration is punishable under18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.					
In consideration of the payment by HeFeChip	Corporation Limited h	aving a postal address of			
Room 3A, 12th floor, Kaiser Centre, No.1	8 Centre Street, Sai Ying	յ Pun, Hong Kong			
(referred to as "ASSIGNEE"below) to I of the sum of One Dollar (\$ 1.00), the receipt of which is hereby acknowledged, andfor other good and valuable consideration.					
I hereby sell, assign and transfer to ASSIGNEE and the successors and assignees of the ASSIGNEE the entire right, title and interest in and to any and all improvements which are disclosed in the invention as above-identified application and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof.					
I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;					
I further covenant that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to I and will testify as to the same in any interference, litigation proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal					
representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof. IN WITNESS WHEREOF, I have hereunto set hand and seal this on the date(s) indicated.					
Note: An application data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form. Use this form for each additional inventor.					

Page 1 of 2

Docket No HFCP0027USA

LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor:

Geeng-Chuan Chern

Date:

NPO#HFC-P0027-USA:0

CUST#

Page 2 of 2

DSB0-109U010676 **PATENT**

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RECORDED: 04/13/2020 REEL: 052374 FRAME: 0554